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CORRECTION

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Correction: Liquid-phase exfoliated SnS as a semiconductor coating filler to enhance corrosion protection performance

Hongyu Tang, ab Zuopeng Qu, *C Lei Wang, Huaiyu Ye, *de Xuejun Fan and Guogi Zhang*a

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The Royal Society of Chemistry apologises for these errors and any consequent inconvenience to authors and readers.

a Department of Microelectronics, Faculty of Electronic, Mathematics and Information, Delft University of Technology, Delft 2628 CT, The Netherlands.

^b Changzhou Institute of Technology Research for Solid State Lighting, Changzhou, 213161, China

^c School of Renewable Energy, North China Electric Power University, Beijing, 102206, China. E-mail: z.qu@ncepu.edu.cn

d School of Microelectronics, Southern University of Science and Technology, Shenzhen 518055, China. E-mail: yehy@sustech.edu.cn

^e Shenzhen Institute of Wide-bandgap Semiconductors, Shenzhen 518055, Guangdong, China

f Department of Mechanical Engineering, Lamar University, Beaumont, TX, USA